

N-Channel Enhancement Mode MOSFET

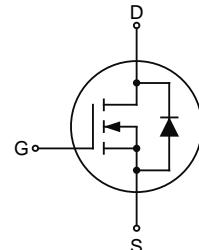
1. Product Information

1.1 Features

Shielded Gate Trench Technology

Excellent low $R_{DS(ON)}$

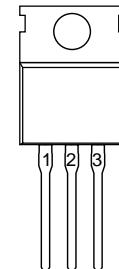
Low gate charge



1.2 Applications

DC/DC converter

Power management switches



Top View
TO-220

1.3 Quick reference

$V_{DS} = 150 \text{ V}$

$I_D = 140 \text{ A}$

$R_{DS(ON)} \leq 9 \text{ m}\Omega @ V_{GS} = 10\text{V}$ (Type: 7.5 mΩ)

2. Package Marking and Ordering Information

Product Name	Package	Marking	Reel size	Tape width	Quantity (pcs)
KJ0815C	TO-220	KJ0815C YWWXXX	N/A	N/A	1000

3. Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	150	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current, $T_C=25^\circ\text{C}$ ^{1, 2}	140	A
	Continuous Drain Current, $T_C=100^\circ\text{C}$ ^{1, 2}	60	A
I_{DM}	Pulsed Drain Current ^{1, 2}	550	A
I_{AS}	Avalanche Current	65	A
E_{AS}	Single Pulse Avalanche Energy ³	506	mJ
P_D	Power Dissipation ⁴	147	W
T_J, T_{stg}	Operating Junction and Storage Temperature Range	-55 to 150	°C
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹	25	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	0.85	°C/W

4. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0 \text{ V}, \text{I}_{\text{DS}}=250 \mu\text{A}$	150	-	-	V
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_{\text{DS}}=250 \mu\text{A}$	2.0	-	4.5	V
I_{DSS}	Drain Leakage Current	$\text{V}_{\text{DS}}=150 \text{ V}, \text{V}_{\text{GS}}=0 \text{ V}$	-	-	1	μA
I_{GSS}	Gate Leakage Current	$\text{V}_{\text{GS}}=0 \text{ V}, \text{V}_{\text{GS}}=\pm 20 \text{ V}$	-	-	± 100	nA
$\text{R}_{\text{DS(ON)}}$	On-State Resistance ⁴	$\text{V}_{\text{GS}}=10 \text{ V}, \text{I}_{\text{DS}}=20 \text{ A}$	-	7.5	9.0	mΩ
g_{FS}	Forward Transconductance ⁴	$\text{V}_{\text{GS}}=5 \text{ V}, \text{I}_{\text{DS}}=20 \text{ A}$	-	60	-	S
R_g	Gate Resistance	Frequency=1 MHz	-	2.5	-	Ω
Diode Characteristics						
V_{SD}	Diode Forward Voltage	$\text{I}_{\text{SD}}=20 \text{ A}, \text{V}_{\text{GS}}=0 \text{ V}$	-	-	1.2	V
t_{rr}	Reverse Recovery Time	$\text{I}_{\text{DS}}=20 \text{ A}, \text{V}_{\text{GS}}=0 \text{ V}, \frac{d\text{I}_{\text{SD}}}{dt}=100 \text{ A}/\mu\text{s}$	-	98	-	ns
Q_{rr}	Reverse Recovery Charge		-	320	-	nC
Dynamic Characteristics						
C_{iss}	Input Capacitance	$\text{V}_{\text{GS}}=10 \text{ V}, \text{V}_{\text{DS}}=75 \text{ V}, \text{I}_{\text{DS}}=20 \text{ A}, \text{Frequency}=1 \text{ MHz}$	-	2184	-	pF
C_{oss}	Output Capacitance		-	360	-	
C_{rss}	Reverse Transfer Capacitance		-	8	-	
$\text{t}_{\text{d(on)}}$	Turn-on Delay Time	$\text{V}_{\text{DS}}=75 \text{ V}, \text{V}_{\text{GEN}}=10 \text{ V}, \text{R}_g=3 \Omega, \text{I}_{\text{DS}}=20 \text{ A}$	-	13	-	ns
t_r	Turn-on Rise Time		-	24	-	
$\text{t}_{\text{d(off)}}$	Turn-off Delay Time		-	30	-	
t_f	Turn-off Fall Time		-	25	-	
Gate Charge Characteristics						
Q_g	Total Gate Charge	$\text{V}_{\text{DS}}=75 \text{ V}, \text{V}_{\text{GS}}=10 \text{ V}, \text{I}_{\text{DS}}=20 \text{ A}$	-	30	-	nC
Q_{gs}	Gate-Source Charge		-	7.5	-	
Q_{gd}	Gate-Drain Charge		-	6.6	-	

Notes:

- Tested by surface mounted on a 1 inch² FR-4 board with 2 OZ copper.
- Tested by pulsed, pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- The E_{AS} data shows Max. rating. The test condition is $\text{V}_{\text{DD}}=50 \text{ V}, \text{V}_{\text{GS}}=10 \text{ V}, \text{L}=0.5 \text{ mH}, \text{I}_{\text{AS}}=45 \text{ A}$.
- The power dissipation is limited by 150°C junction temperature.
- The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

5. Typical Characteristics

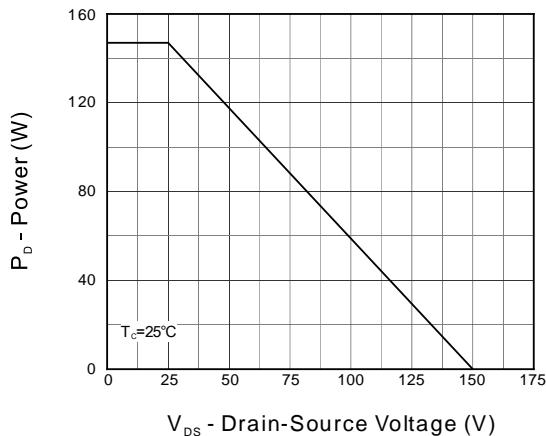


Figure 1. Output Characteristics

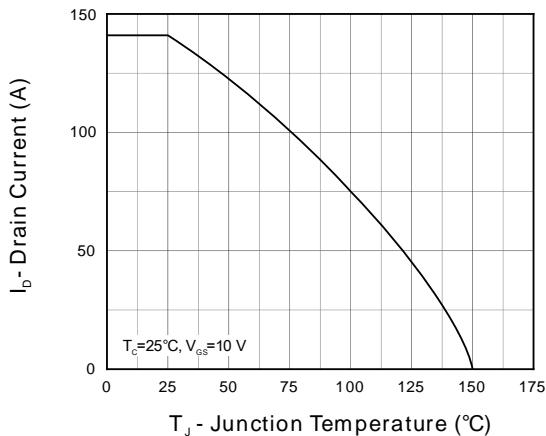


Figure 2. Current Capability

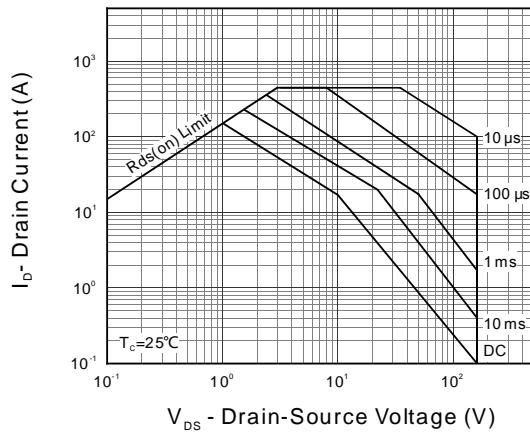


Figure 3. Safe Operation Area

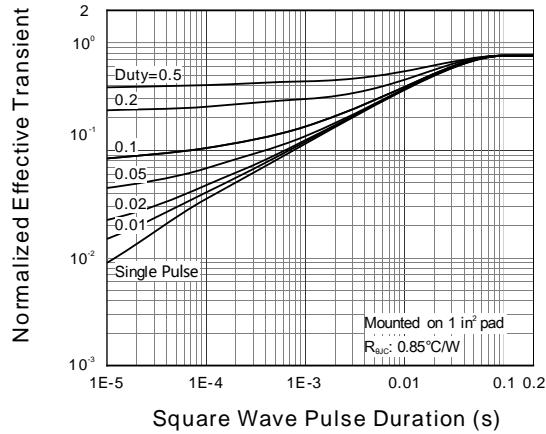


Figure 4. Transient Thermal Impedance

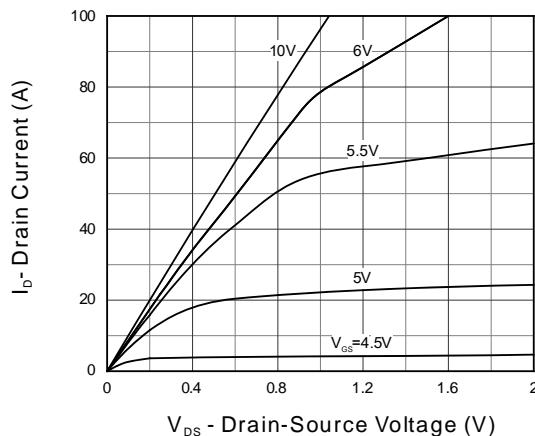


Figure 5. Output Characteristics

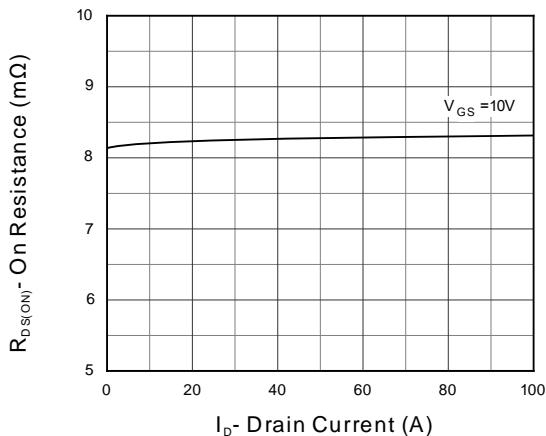
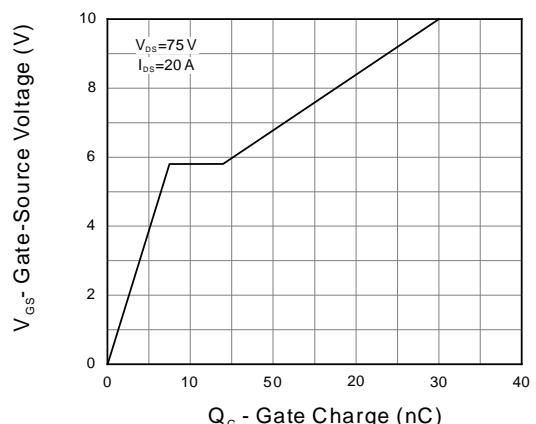
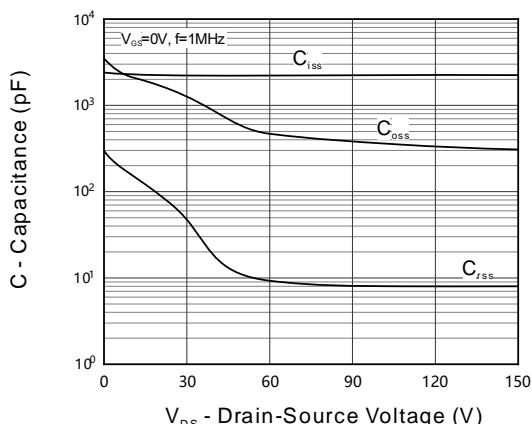
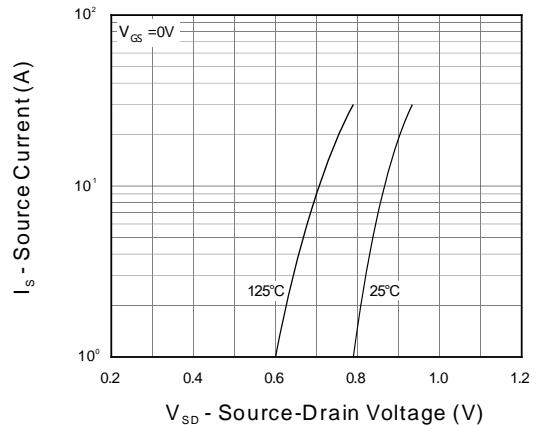
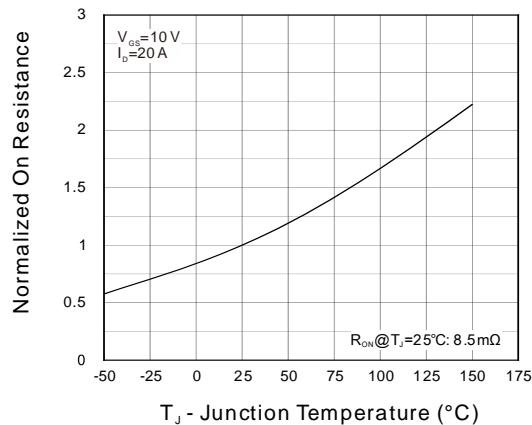
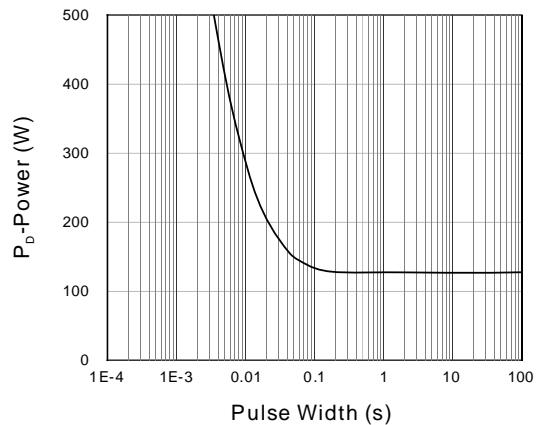
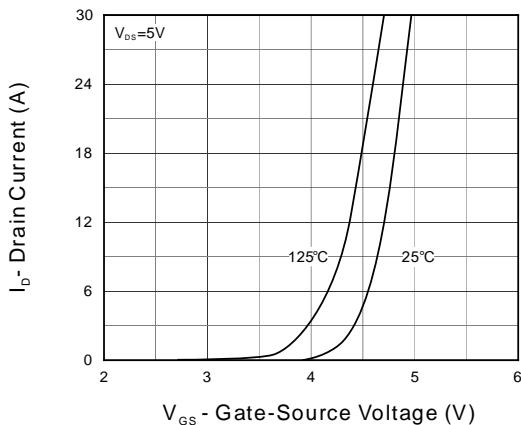


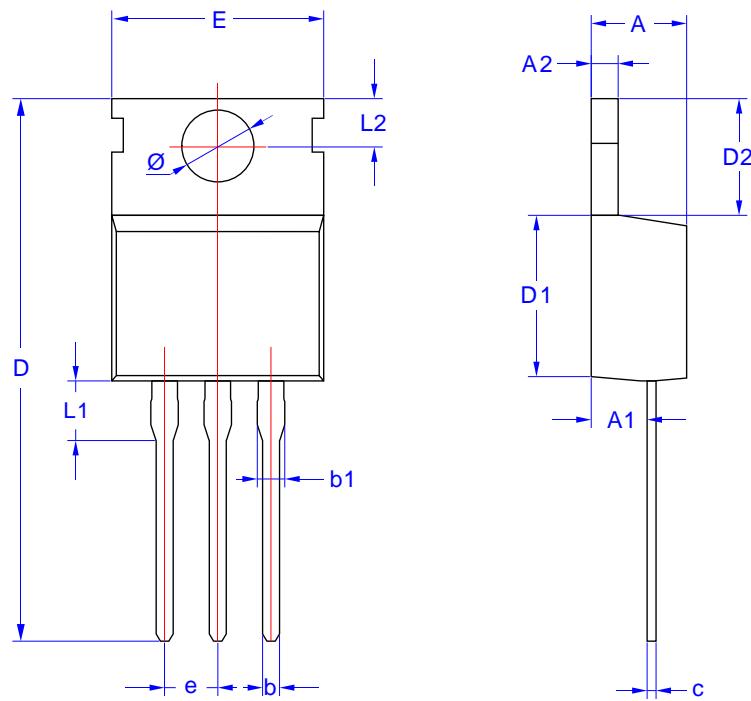
Figure 6. On Resistance

5. Typical Characteristics (cont.)



6. Package Dimensions

TO-220 Package



Symbol	Dimensions in Millimeters	
	MIN	MAX
A	4.24	4.70
A1	2.20	3.00
A2	1.15	1.40
b	0.70	0.95
b1	1.14	1.70
c	0.40	0.60
D	28.0	29.8
D1	8.80	9.90
D2	6.25	6.90
E	9.70	10.50
L1	3.80	
L2	2.40	3.00
e	2.54 BSC	
Φ	3.60	